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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

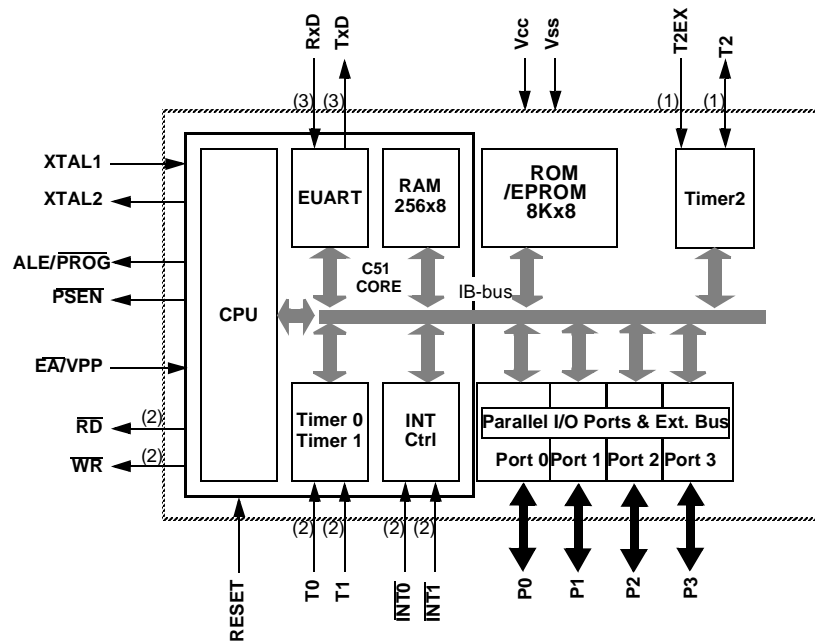
#### Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	60/30MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-VQFP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/ts80c32x2-vce">https://www.e-xfl.com/product-detail/microchip-technology/ts80c32x2-vce</a>

**Table 1. Memory Size**

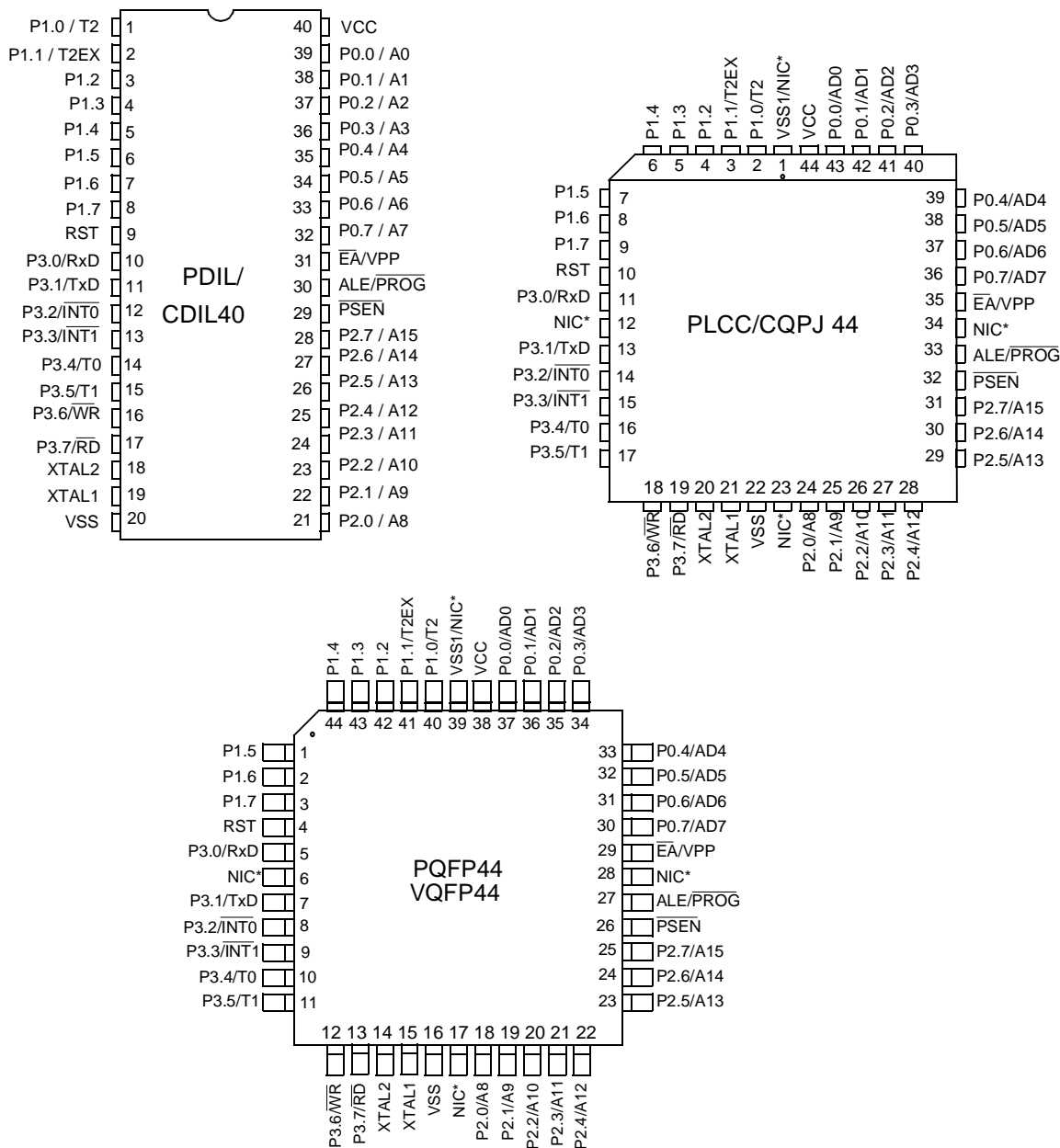
	ROM (bytes)	EPROM (bytes)	TOTAL RAM (bytes)
TS80C32X2	0	0	256
TS80C52X2	8k	0	256
TS87C52X2	0	8k	256

## Block Diagram



- Notes:
1. Alternate function of Port 1
  2. Alternate function of Port 3

## Pin Configuration



\*NIC: No Internal Connection

Mnemonic	Pin Number			Type	Name and Function
	DIL	LCC	VQFP 1.4		
V <sub>SS</sub>	20	22	16	I	<b>Ground:</b> 0V reference
V <sub>SS1</sub>		1	39	I	Optional Ground: <b>Contact the Sales Office for ground connection.</b>
V <sub>CC</sub>	40	44	38	I	<b>Power Supply:</b> This is the power supply voltage for normal, idle and power-down operation
P0.0-P0.7	39-32	43-36	37-30	I/O	<b>Port 0:</b> Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as high impedance inputs. Port 0 pins must be polarized to V <sub>CC</sub> or V <sub>SS</sub> in order to prevent any parasitic current consumption. Port 0 is also the multiplexed low-order address and data bus during access to external program and data memory. In this application, it uses strong internal pull-up when emitting 1s. Port 0 also inputs the code bytes during EPROM programming. External pull-ups are required during program verification during which P0 outputs the code bytes.
P1.0-P1.7	1-8	2-9	40-44 1-3	I/O	<b>Port 1:</b> Port 1 is an 8-bit bidirectional I/O port with internal pull-ups. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 1 pins that are externally pulled low will source current because of the internal pull-ups. Port 1 also receives the low-order address byte during memory programming and verification.  Alternate functions for Port 1 include:
	1	2	40	I/O	<b>T2 (P1.0):</b> Timer/Counter 2 external count input/Clockout
	2	3	41	I	<b>T2EX (P1.1):</b> Timer/Counter 2 Reload/Capture/Direction Control
P2.0-P2.7	21-28	24-31	18-25	I/O	<b>Port 2:</b> Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally pulled low will source current because of the internal pull-ups. Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX atDPTR). In this application, it uses strong internal pull-ups emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX atRi), port 2 emits the contents of the P2 SFR. Some Port 2 pins receive the high order address bits during EPROM programming and verification: P2.0 to P2.4
P3.0-P3.7	10-17	11, 13-19	5, 7-13	I/O	<b>Port 3:</b> Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally pulled low will source current because of the internal pull-ups. Port 3 also serves the special features of the 80C51 family, as listed below.
	10	11	5	I	<b>RXD (P3.0):</b> Serial input port
	11	13	7	O	<b>TXD (P3.1):</b> Serial output port
	12	14	8	I	<b>INT0 (P3.2):</b> External interrupt 0

## Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.

### ASSEMBLY LANGUAGE

```

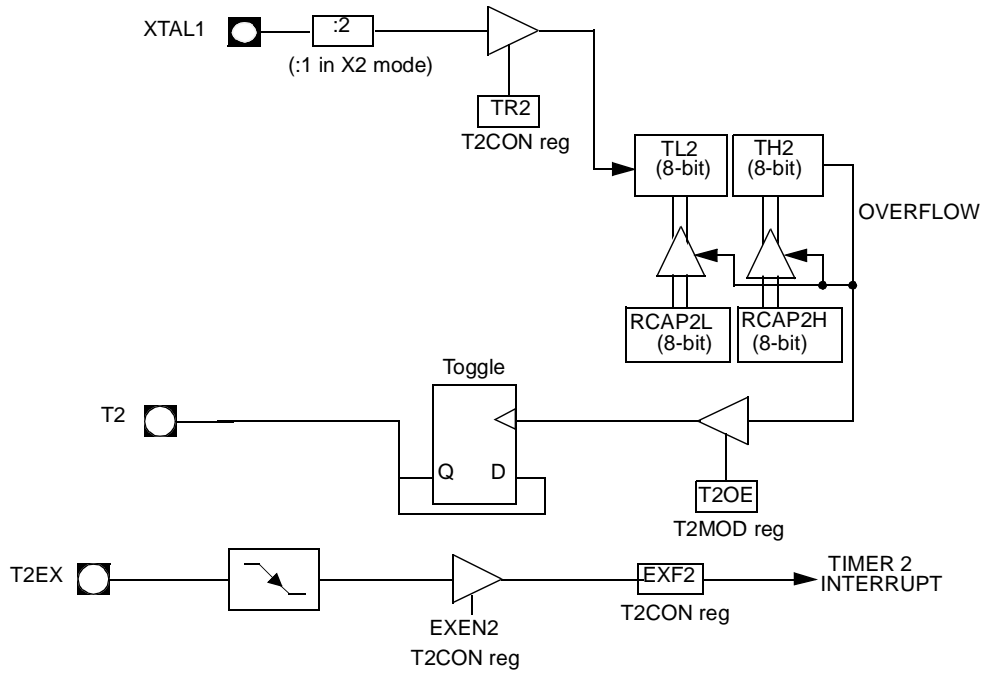
; Block move using dual data pointers
; Destroys DPTR0, DPTR1, A and PSW
; note: DPS exits opposite of entry state
; unless an extra INC AUXR1 is added
;
00A2  AUXR1 EQU 0A2H
;
0000 909000 MOV DPTR,#SOURCE ; address of SOURCE
0003 05A2 INC AUXR1 ; switch data pointers
0005 90A000 MOV DPTR,#DEST ; address of DEST
0008  LOOP:
0008 05A2 INC AUXR1 ; switch data pointers
000A E0 MOVX A,atDPTR ; get a byte from SOURCE
000B A3 INC DPTR ; increment SOURCE address
000C 05A2 INC AUXR1 ; switch data pointers
000E F0 MOVX atDPTR,A ; write the byte to DEST
000F A3 INC DPTR ; increment DEST address
0010 70F6 JNZ LOOP ; check for 0 terminator
0012 05A2 INC AUXR1 ; (optional) restore DPS

```

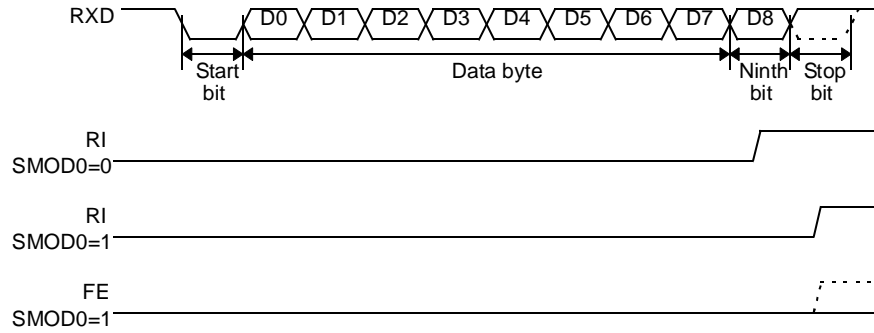
INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.



**Figure 5.** Clock-Out Mode  $C/\overline{T2} = 0$



**Figure 8. UART Timings in Modes 2 and 3**



### Automatic Address Recognition

The automatic address recognition feature is enabled when the multiprocessor communication feature is enabled (SM2 bit in SCON register is set).

Implemented in hardware, automatic address recognition enhances the multiprocessor communication feature by allowing the serial port to examine the address of each incoming command frame. Only when the serial port recognizes its own address, the receiver sets RI bit in SCON register to generate an interrupt. This ensures that the CPU is not interrupted by command frames addressed to other devices.

If desired, you may enable the automatic address recognition feature in mode 1. In this configuration, the stop bit takes the place of the ninth data bit. Bit RI is set only when the received command frame address matches the device's address and is terminated by a valid stop bit.

To support automatic address recognition, a device is identified by a given address and a broadcast address.

**Note:** The multiprocessor communication and automatic address recognition features cannot be enabled in mode 0 (i.e. setting SM2 bit in SCON register in mode 0 has no effect).

### Given Address

Each device has an individual address that is specified in SADDR register; the SADEN register is a mask byte that contains don't-care bits (defined by zeros) to form the device's given address. The don't-care bits provide the flexibility to address one or more slaves at a time. The following example illustrates how a given address is formed.

To address a device by its individual address, the SADEN mask byte must be 1111 1111b.

For example:

```
SADDR0101 0110b
SADEN1111 1100b
Given0101 01XXb
```

The following is an example of how to use given addresses to address different slaves:

```
Slave A:SADDR1111 0001b
SADEN1111 1010b
Given1111 0X0Xb
```

```
Slave B:SADDR1111 0011b
SADEN1111 1001b
Given1111 0XX1b
```

```
Slave C:SADDR1111 0010b
SADEN1111 1101b
Given1111 00X1b
```

The SADEN byte is selected so that each slave may be addressed separately.

For slave A, bit 0 (the LSB) is a don't-care bit; for slaves B and C, bit 0 is a 1. To communicate with slave A only, the master must send an address where bit 0 is clear (e.g.

are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

**Table 12.** IE Register  
IE - Interrupt Enable Register (A8h)

7	6	5	4	3	2	1	0
EA	-	ET2	ES	ET1	EX1	ET0	EX0

Bit Number	Bit Mnemonic	Description
7	EA	<b>Enable All interrupt bit</b> Clear to disable all interrupts. Set to enable all interrupts. If EA=1, each interrupt source is individually enabled or disabled by setting or clearing its own interrupt enable bit.
6	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
5	ET2	<b>Timer 2 overflow interrupt Enable bit</b> Clear to disable timer 2 overflow interrupt. Set to enable timer 2 overflow interrupt.
4	ES	<b>Serial port Enable bit</b> Clear to disable serial port interrupt. Set to enable serial port interrupt.
3	ET1	<b>Timer 1 overflow interrupt Enable bit</b> Clear to disable timer 1 overflow interrupt. Set to enable timer 1 overflow interrupt.
2	EX1	<b>External interrupt 1 Enable bit</b> Clear to disable external interrupt 1. Set to enable external interrupt 1.
1	ET0	<b>Timer 0 overflow interrupt Enable bit</b> Clear to disable timer 0 overflow interrupt. Set to enable timer 0 overflow interrupt.
0	EX0	<b>External interrupt 0 Enable bit</b> Clear to disable external interrupt 0. Set to enable external interrupt 0.

Reset Value = 0X00 0000b

Bit addressable



**Table 14.** IPH Register  
IPH - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0
-	-	PT2H	PSH	PT1H	PX1H	PT0H	PX0H

Bit Number	Bit Mnemonic	Description															
7	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.															
6	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.															
5	PT2H	<b>Timer 2 overflow interrupt Priority High bit</b> <table> <tr> <th>PT2H</th><th>PT2</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PT2H	PT2	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PT2H	PT2	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															
4	PSH	<b>Serial port Priority High bit</b> <table> <tr> <th>PSH</th><th>PS</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PSH	PS	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PSH	PS	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															
3	PT1H	<b>Timer 1 overflow interrupt Priority High bit</b> <table> <tr> <th>PT1H</th><th>PT1</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PT1H	PT1	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PT1H	PT1	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															
2	PX1H	<b>External interrupt 1 Priority High bit</b> <table> <tr> <th>PX1H</th><th>PX1</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PX1H	PX1	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PX1H	PX1	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															
1	PT0H	<b>Timer 0 overflow interrupt Priority High bit</b> <table> <tr> <th>PT0H</th><th>PT0</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PT0H	PT0	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PT0H	PT0	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															
0	PX0H	<b>External interrupt 0 Priority High bit</b> <table> <tr> <th>PX0H</th><th>PX0</th><th>Priority Level</th></tr> <tr> <td>0</td><td>0</td><td>Lowest</td></tr> <tr> <td>0</td><td>1</td><td></td></tr> <tr> <td>1</td><td>0</td><td></td></tr> <tr> <td>1</td><td>1</td><td>Highest</td></tr> </table>	PX0H	PX0	Priority Level	0	0	Lowest	0	1		1	0		1	1	Highest
PX0H	PX0	Priority Level															
0	0	Lowest															
0	1																
1	0																
1	1	Highest															

Reset Value = XX00 0000b  
Not bit addressable

## Idle mode

An instruction that sets PCON.0 causes that to be the last instruction executed before going into the Idle mode. In the Idle mode, the internal clock signal is gated off to the CPU, but not to the interrupt, Timer, and Serial Port functions. The CPU status is preserved in its entirety: the Stack Pointer, Program Counter, Program Status Word, Accumulator and all other registers maintain their data during Idle. The port pins hold the logical states they had at the time Idle was activated. ALE and PSEN hold at logic high levels.

There are two ways to terminate the Idle. Activation of any enabled interrupt will cause PCON.0 to be cleared by hardware, terminating the Idle mode. The interrupt will be serviced, and following RETI the next instruction to be executed will be the one following the instruction that put the device into idle.

The flag bits GF0 and GF1 can be used to give an indication if an interrupt occurred during normal operation or during an Idle. For example, an instruction that activates Idle can also set one or both flag bits. When Idle is terminated by an interrupt, the interrupt service routine can examine the flag bits.

The other way of terminating the Idle mode is with a hardware reset. Since the clock oscillator is still running, the hardware reset needs to be held active for only two machine cycles (24 oscillator periods) to complete the reset.

## Power-down Mode

To save maximum power, a power-down mode can be invoked by software (Refer to Table 10., PCON register).

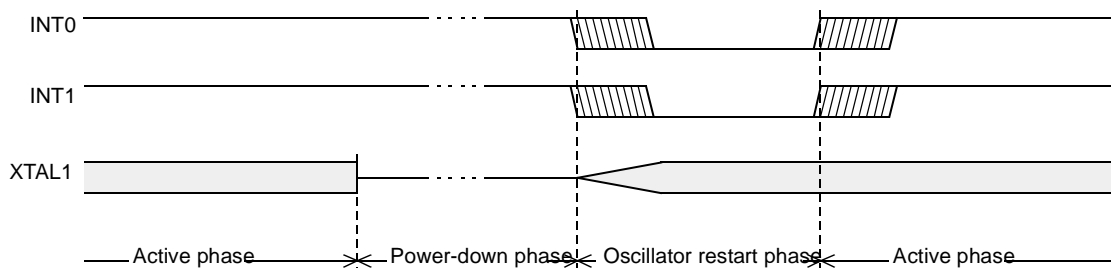
In power-down mode, the oscillator is stopped and the instruction that invoked power-down mode is the last instruction executed. The internal RAM and SFRs retain their value until the power-down mode is terminated.  $V_{CC}$  can be lowered to save further power. Either a hardware reset or an external interrupt can cause an exit from power-down. To properly terminate power-down, the reset or external interrupt should not be executed before  $V_{CC}$  is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize.

Only external interrupts  $\overline{INT0}$  and  $\overline{INT1}$  are useful to exit from power-down. For that, interrupt must be enabled and configured as level or edge sensitive interrupt input.

Holding the pin low restarts the oscillator but bringing the pin high completes the exit as detailed in Figure 10. When both interrupts are enabled, the oscillator restarts as soon as one of the two inputs is held low and power down exit will be completed when the first input will be released. In this case the higher priority interrupt service routine is executed.

Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put TS80C52X2 into power-down mode.

**Figure 10.** Power-down Exit Waveform



## ONCE™ Mode (ON Chip Emulation)

The ONCE mode facilitates testing and debugging of systems using TS80C52X2 without removing the circuit from the board. The ONCE mode is invoked by driving certain pins of the TS80C52X2; the following sequence must be exercised:

- Pull ALE low while the device is in reset (RST high) and  $\overline{\text{PSEN}}$  is high.
- Hold ALE low as RST is deactivated.

While the TS80C52X2 is in ONCE mode, an emulator or test CPU can be used to drive the circuit Table 26. shows the status of the port pins during ONCE mode.

Normal operation is restored when normal reset is applied.

**Table 16.** External Pin Status during ONCE Mode

ALE	PSEN	Port 0	Port 1	Port 2	Port 3	XTAL1/2
Weak pull-up	Weak pull-up	Float	Weak pull-up	Weak pull-up	Weak pull-up	Active

## EPROM Structure

The TS87C52X2 is divided in two different arrays:

- the code array: 8 Kbytes
- the encryption array: 64 bytes

In addition a third non programmable array is implemented:

- the signature array: 4 bytes

## EPROM Lock System

The program Lock system, when programmed, protects the on-chip program against software piracy.

### Encryption Array

Within the EPROM array are 64 bytes of encryption array that are initially unprogrammed (all FF's). Every time a byte is addressed during program verify, 6 address lines are used to select a byte of the encryption array. This byte is then exclusive-NOR'ed (XNOR) with the code byte, creating an encrypted verify byte. The algorithm, with the encryption array in the unprogrammed state, will return the code in its original, unmodified form.

When using the encryption array, one important factor needs to be considered. If a byte has the value FFh, verifying the byte will produce the encryption byte value. If a large block (>64 bytes) of code is left unprogrammed, a verification routine will display the content of the encryption array. For this reason all the unused code bytes should be programmed with random values. This will ensure program protection.

### Program Lock Bits

The three lock bits, when programmed according to Table 1., will provide different level of protection for the on-chip code and data.

Program Lock Bits				Protection Description
Security level	LB1	LB2	LB3	
1	U	U	U	No program lock features enabled. Code verify will still be encrypted by the encryption array if programmed. MOVC instruction executed from external program memory returns non encrypted data.
2	P	U	U	MOVC instruction executed from external program memory are disabled from fetching code bytes from internal memory, EA is sampled and latched on reset, and further programming of the EPROM is disabled.
3	U	P	U	Same as 2, also verify is disabled.
4	U	U	P	Same as 3, also external execution is disabled.

U: unprogrammed

P: programmed

**WARNING:** Security level 2 and 3 should only be programmed after EPROM and Core verification.

### Signature Bytes

The TS80/87C52X2 contains 4 factory programmed signatures bytes. To read these bytes, perform the process described in section 9.

## EPROM Programming

### Set-up modes

In order to program and verify the EPROM or to read the signature bytes, the TS87C52X2 is placed in specific set-up modes (See Figure 11.).

## Programming Algorithm

The Improved Quick Pulse algorithm is based on the Quick Pulse algorithm and decreases the number of pulses applied during byte programming from 25 to 1.

To program the TS87C52X2 the following sequence must be exercised:

- Step 1: Activate the combination of control signals.
- Step 2: Input the valid address on the address lines.
- Step 3: Input the appropriate data on the data lines.
- Step 4: Raise  $\overline{EA}/VPP$  from VCC to VPP (typical 12.75V).
- Step 5: Pulse ALE/ $\overline{PROG}$  once.
- Step 6: Lower  $\overline{EA}/VPP$  from VPP to VCC

Repeat step 2 through 6 changing the address and data for the entire array or until the end of the object file is reached (See Figure 12.).

## Verify Algorithm

Code array verify must be done after each byte or block of bytes is programmed. In either case, a complete verify of the programmed array will ensure reliable programming of the TS87C52X2.

P 2.7 is used to enable data output.

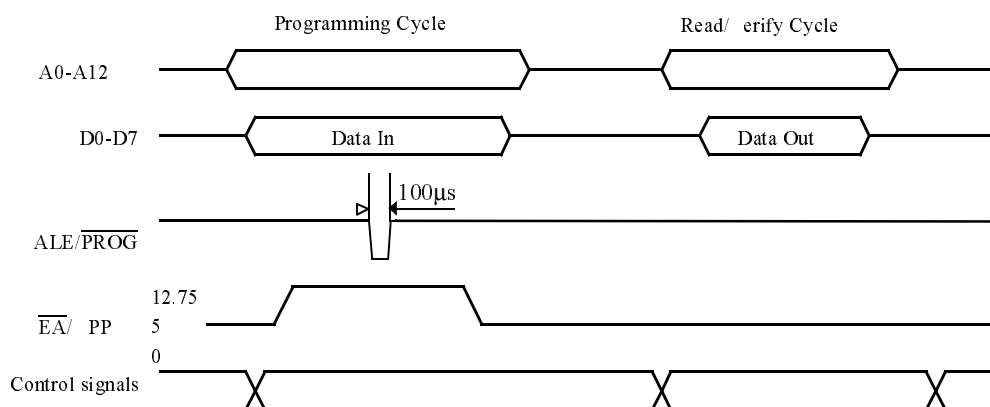
To verify the TS87C52X2 code the following sequence must be exercised:

- Step 1: Activate the combination of program and control signals.
- Step 2: Input the valid address on the address lines.
- Step 3: Read data on the data lines.

Repeat step 2 through 3 changing the address for the entire array verification (See Figure 12.)

The encryption array cannot be directly verified. Verification of the encryption array is done by observing that the code array is well encrypted.

**Figure 12.** Programming and Verification Signal's Waveform



## EPROM Erasure (Windowed Packages Only)

Erasing the EPROM erases the code array, the encryption array and the lock bits returning the parts to full functionality.

Erasure leaves all the EPROM cells in a 1's state (FF).

## Erasure Characteristics

The recommended erasure procedure is exposure to ultraviolet light (at 2537 Å) to an integrated dose at least 15 W-sec/cm<sup>2</sup>. Exposing the EPROM to an ultraviolet lamp of

## Electrical Characteristics

### Absolute Maximum Ratings<sup>(1)</sup>

Ambient Temperature Under Bias:

C = commercial.....0°C to 70°C  
 I = industrial .....-40°C to 85°C  
 Storage Temperature ..... -65°C to + 150°C  
 Voltage on V<sub>CC</sub> to V<sub>SS</sub>.....-0.5V to + 7 V  
 Voltage on V<sub>PP</sub> to V<sub>SS</sub>.....-0.5V to + 13 V  
 Voltage on Any Pin to V<sub>SS</sub>.....-0.5V to V<sub>CC</sub> + 0.5V  
 Power Dissipation ..... 1 W<sup>(2)</sup>

- Notes: 1. Stresses at or above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
2. This value is based on the maximum allowable die temperature and the thermal resistance of the package.

### Power Consumption Measurement

Since the introduction of the first C51 devices, every manufacturer made operating I<sub>cc</sub> measurements under reset, which made sense for the designs where the CPU was running under reset. In Atmel new devices, the CPU is no more active during reset, so the power consumption is very low but is not really representative of what will happen in the customer system. That's why, while keeping measurements under Reset, Atmel presents a new way to measure the operating I<sub>cc</sub>:

Using an internal test ROM, the following code is executed:

Label: SJMP Label (80 FE)

Ports 1, 2, 3 are disconnected, Port 0 is tied to FFh, EA = V<sub>CC</sub>, RST = V<sub>SS</sub>, XTAL2 is not connected and XTAL1 is driven by the clock.

This is much more representative of the real operating I<sub>cc</sub>.

### DC Parameters for Standard Voltage

T<sub>A</sub> = 0°C to +70°C; V<sub>SS</sub> = 0 V; V<sub>CC</sub> = 5V ± 10%; F = 0 to 40 MHz.  
 T<sub>A</sub> = -40°C to +85°C; V<sub>SS</sub> = 0 V; V<sub>CC</sub> = 5V ± 10%; F = 0 to 40 MHz.

**Table 22.** DC Parameters in Standard Voltage

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V <sub>IL</sub>	Input Low Voltage	-0.5		0.2 V <sub>CC</sub> - 0.1	V	
V <sub>IH</sub>	Input High Voltage except XTAL1, RST	0.2 V <sub>CC</sub> + 0.9		V <sub>CC</sub> + 0.5	V	
V <sub>IH1</sub>	Input High Voltage, XTAL1, RST	0.7 V <sub>CC</sub>		V <sub>CC</sub> + 0.5	V	
V <sub>OL</sub>	Output Low Voltage, ports 1, 2, 3 <sup>(6)</sup>			0.3	V	I <sub>OL</sub> = 100 μA <sup>(4)</sup>
				0.45	V	I <sub>OL</sub> = 1.6 mA <sup>(4)</sup>
				1.0	V	I <sub>OL</sub> = 3.5 mA <sup>(4)</sup>
V <sub>OL1</sub>	Output Low Voltage, port 0 <sup>(6)</sup>			0.3	V	I <sub>OL</sub> = 200 μA <sup>(4)</sup>
				0.45	V	I <sub>OL</sub> = 3.2 mA <sup>(4)</sup>
				1.0	V	I <sub>OL</sub> = 7.0 mA <sup>(4)</sup>
V <sub>OL2</sub>	Output Low Voltage, ALE, $\overline{\text{PSEN}}$			0.3	V	I <sub>OL</sub> = 100 μA <sup>(4)</sup>
				0.45	V	I <sub>OL</sub> = 1.6 mA <sup>(4)</sup>
				1.0	V	I <sub>OL</sub> = 3.5 mA <sup>(4)</sup>

**Table 22.** DC Parameters in Standard Voltage (Continued)

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
$V_{OH}$	Output High Voltage, ports 1, 2, 3	$V_{CC} - 0.3$ $V_{CC} - 0.7$ $V_{CC} - 1.5$			V V V	$I_{OH} = -10 \mu A$ $I_{OH} = -30 \mu A$ $I_{OH} = -60 \mu A$ $V_{CC} = 5V \pm 10\%$
$V_{OH1}$	Output High Voltage, port 0	$V_{CC} - 0.3$ $V_{CC} - 0.7$ $V_{CC} - 1.5$			V V V	$I_{OH} = -200 \mu A$ $I_{OH} = -3.2 mA$ $I_{OH} = -7.0 mA$ $V_{CC} = 5V \pm 10\%$
$V_{OH2}$	Output High Voltage, ALE, $\overline{PSEN}$	$V_{CC} - 0.3$ $V_{CC} - 0.7$ $V_{CC} - 1.5$			V V V	$I_{OH} = -100 \mu A$ $I_{OH} = -1.6 mA$ $I_{OH} = -3.5 mA$ $V_{CC} = 5V \pm 10\%$
$R_{RST}$	RST Pulldown Resistor	50	90 <sup>(5)</sup>	200	k $\Omega$	
$I_{IL}$	Logical 0 Input Current ports 1, 2 and 3			-50	$\mu A$	$V_{in} = 0.45V$
$I_{LI}$	Input Leakage Current			$\pm 10$	$\mu A$	$0.45V < V_{in} < V_{CC}$
$I_{TL}$	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	$\mu A$	$V_{in} = 2.0 V$
$C_{IO}$	Capacitance of I/O Buffer			10	pF	$F_c = 1 MHz$ $T_A = 25^\circ C$
$I_{PD}$	Power Down Current		20 <sup>(5)</sup>	50	$\mu A$	$2.0 V < V_{CC} < 5.5V^{(3)}$
$I_{CC}$ under RESET	Power Supply Current Maximum values, X1 mode: <sup>(7)</sup>			1 + 0.4 Freq (MHz) at 12MHz 5.8 at 16MHz 7.4	mA	$V_{CC} = 5.5V^{(1)}$
$I_{CC}$ operating	Power Supply Current Maximum values, X1 mode: <sup>(7)</sup>			3 + 0.6 Freq (MHz) at 12MHz 10.2 at 16MHz 12.6	mA	$V_{CC} = 5.5V^{(8)}$
$I_{CC}$ idle	Power Supply Current Maximum values, X1 mode: <sup>(7)</sup>			0.25+0.3 Freq (MHz) at 12MHz 3.9 at 16MHz 5.1	mA	$V_{CC} = 5.5V^{(2)}$

Table 28., Table 31. and Table 34. give the frequency derating formula of the AC parameter. To calculate each AC symbols, take the x value corresponding to the speed grade you need (-M, -V or -L) and replace this value in the formula. Values of the frequency must be limited to the corresponding speed grade:

**Table 25.** Max frequency for derating formula regarding the speed grade

	-M X1 mode	-M X2 mode	-V X1 mode	-V X2 mode	-L X1 mode	-L X2 mode
<b>Freq (MHz)</b>	40	20	40	30	30	20
<b>T (ns)</b>	25	50	25	33.3	33.3	50

Example:

$T_{LLIV}$  in X2 mode for a -V part at 20 MHz ( $T = 1/20^{E6} = 50$  ns):

$x = 22$  (Table 28.)

$T = 50$  ns

$T_{LLIV} = 2T - x = 2 \times 50 - 22 = 78$  ns

## External Program Memory Characteristics

**Table 26.** Symbol Description

Symbol	Parameter
T	Oscillator clock period
$T_{LHLL}$	ALE pulse width
$T_{AVLL}$	Address Valid to ALE
$T_{LLAX}$	Address Hold After ALE
$T_{LLIV}$	ALE to Valid Instruction In
$T_{LLPL}$	ALE to $\overline{PSEN}$
$T_{PLPH}$	$\overline{PSEN}$ Pulse Width
$T_{PLIV}$	$\overline{PSEN}$ to Valid Instruction In
$T_{PXIX}$	Input Instruction Hold After $\overline{PSEN}$
$T_{PXIZ}$	Input Instruction Float After $\overline{PSEN}$
$T_{PXAV}$	$\overline{PSEN}$ to Address Valid
$T_{AVIV}$	Address to Valid Instruction In
$T_{PLAZ}$	$\overline{PSEN}$ Low to Address Float

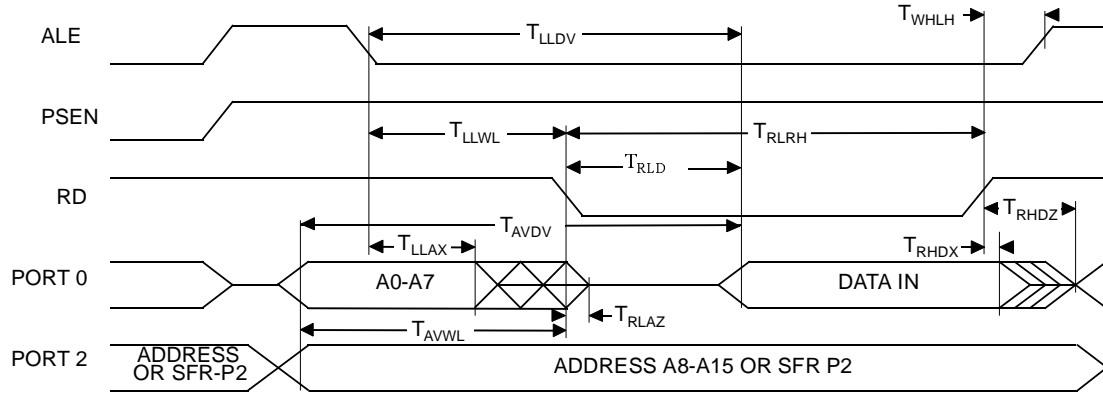


**Table 30. AC Parameters for a Fix Clock**

Speed	-M 40 MHz		-V X2 mode 30 MHz 60 MHz equiv.		-V standard mode 40 MHz		-L X2 mode 20 MHz 40 MHz equiv.		-L standard mode 30 MHz		Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$T_{RLRH}$	130		85		135		125		175		ns
$T_{WLWH}$	130		85		135		125		175		ns
$T_{RLDV}$		100		60		102		95		137	ns
$T_{RHDV}$	0		0		0		0		0		ns
$T_{RHDZ}$		30		18		35		25		42	ns
$T_{LLDV}$		160		98		165		155		222	ns
$T_{AVDV}$		165		100		175		160		235	ns
$T_{LLWL}$	50	100	30	70	55	95	45	105	70	130	ns
$T_{AVWL}$	75		47		80		70		103		ns
$T_{QVWX}$	10		7		15		5		13		ns
$T_{QVWH}$	160		107		165		155		213		ns
$T_{WHQX}$	15		9		17		10		18		ns
$T_{RLAZ}$		0		0		0		0		0	ns
$T_{WHLH}$	10	40	7	27	15	35	5	45	13	53	ns

## External Data Memory Read Cycle

**Figure 20.** External Data Memory Read Cycle



## Serial Port Timing - Shift Register Mode

**Table 32.** Symbol Description

Symbol	Parameter
$T_{XLXL}$	Serial port clock cycle time
$T_{QVHX}$	Output data set-up to clock rising edge
$T_{XHGX}$	Output data hold after clock rising edge
$T_{XHDX}$	Input data hold after clock rising edge
$T_{XHDV}$	Clock rising edge to input data valid

**Table 33.** AC Parameters for a Fix Clock

Speed	-M 40 MHz		-V X2 mode 30 MHz 60 MHz equiv.		-V standard mode 40 MHz		-L X2 mode 20 MHz 40 MHz equiv.		-L standard mode 30 MHz		Units
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$T_{XLXL}$	300		200		300		300		400		ns
$T_{QVHX}$	200		117		200		200		283		ns
$T_{XHGX}$	30		13		30		30		47		ns
$T_{XHDX}$	0		0		0		0		0		ns
$T_{XHDV}$		117		34		117		117		200	ns

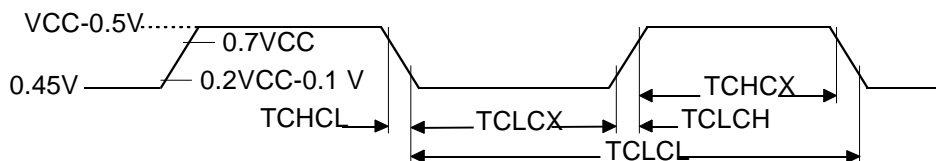
## External Clock Drive Characteristics (XTAL1)

**Table 36.** AC Parameters

Symbol	Parameter	Min	Max	Units
$T_{CLCL}$	Oscillator Period	25		ns
$T_{CHCX}$	High Time	5		ns
$T_{CLCX}$	Low Time	5		ns
$T_{CLCH}$	Rise Time		5	ns
$T_{CHCL}$	Fall Time		5	ns
$T_{CHCX}/T_{CLCX}$	Cyclic ratio in X2 mode	40	60	%

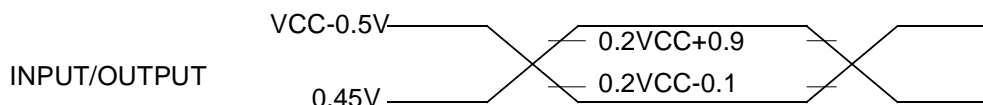
## External Clock Drive Waveforms

**Figure 23.** External Clock Drive Waveforms



## AC Testing Input/Output Waveforms

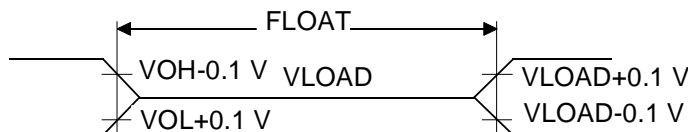
**Figure 24.** AC Testing Input/Output Waveforms



AC inputs during testing are driven at  $V_{CC} - 0.5$  for a logic “1” and 0.45V for a logic “0”. Timing measurement are made at  $V_{IH}$  min for a logic “1” and  $V_{IL}$  max for a logic “0”.

## Float Waveforms

**Figure 25.** Float Waveforms

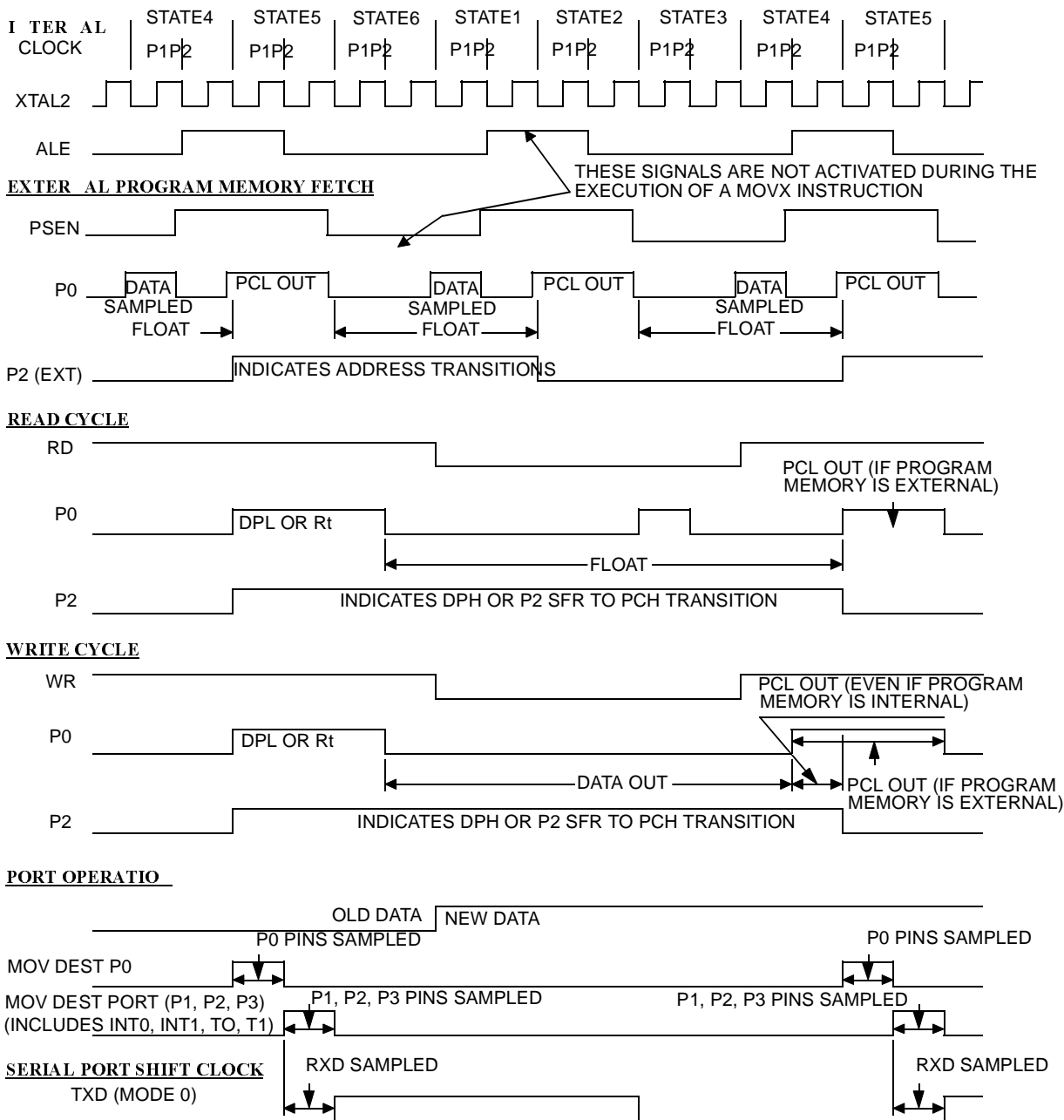


For timing purposes a port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loaded  $V_{OH}/V_{OL}$  level occurs.  $I_{OL}/I_{OH} \geq \pm 20mA$ .

## Clock Waveforms

Valid in normal clock mode. In X2 mode XTAL2 signal must be changed to XTAL2 divided by two.

**Figure 26. Clock Waveforms**



This diagram indicates when signals are clocked internally. The time it takes the signals to propagate to the pins, however, ranges from 25 to 125 ns. This propagation delay is dependent on variables such as temperature and pin loading. Propagation also varies from output to output and component. Typically though ( $T_A = 25^\circ\text{C}$  fully loaded)  $\overline{\text{RD}}$  and  $\overline{\text{WR}}$  propagation delays are approximately 50ns. The other signals are typically 85 ns. Propagation delays are incorporated in the AC specifications.

**Table 37. Possible Ordering Entries (Continued)**

Part Number <sup>(3)</sup>	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
<b>AT87C52X2-3CSUM</b>	8K OTP	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PDIL40	Stick
<b>AT87C52X2-SLSUM</b>	8K OTP	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PLCC44	Stick
<b>AT87C52X2-RLTUM</b>	8K OTP	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	VQFP44	Tray
<b>AT87C52X2-3CSUL</b>	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PDIL40	Stick
<b>AT87C52X2-SLSUL</b>	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PLCC44	Stick
<b>AT87C52X2-RLTUL</b>	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	VQFP44	Tray
<b>AT87C52X2-3CSUV</b>	8K OTP	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PDIL40	Stick
<b>AT87C52X2-SLSUV</b>	8K OTP	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PLCC44	Stick
<b>AT87C52X2-RLTUV</b>	8K OTP	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	VQFP44	Tray

- Notes:
1. 20 MHz in X2 Mode.
  2. Tape and Reel available for SL, PQFP and RL packages
  3. 30 MHz in X2 Mode.